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#### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

Product Status	Discontinued at Digi-Key
Core Processor	RL78
Core Size	16-Bit
Speed	32MHz
Connectivity	CSI, I <sup>2</sup> C, LINbus, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	21
Program Memory Size	48KB (48K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	3K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	30-LSSOP (0.240", 6.10mm Width)
Supplier Device Package	30-LSSOP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f101adasp-v0">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f101adasp-v0</a>

**Table 1-1. List of Ordering Part Numbers**

(1/12)

Pin count	Package	Data flash	Fields of Application <sup>Note</sup>	Ordering Part Number
20 pins	20-pin plastic LSSOP (7.62 mm (300), 0.65 mm pitch)	Mounted	A	R5F1006AASP#V0, R5F1006CASP#V0, R5F1006DASP#V0, R5F1006EASP#V0 R5F1006AASP#X0, R5F1006CASP#X0, R5F1006DASP#X0, R5F1006EASP#X0
			D	R5F1006ADSP#V0, R5F1006CDSP#V0, R5F1006DDSP#V0, R5F1006EDSP#V0 R5F1006ADSP#X0, R5F1006CDSP#X0, R5F1006DDSP#X0, R5F1006EDSP#X0
			G	R5F1006AGSP#V0, R5F1006CGSP#V0, R5F1006DGSP#V0, R5F1006EGSP#V0 R5F1006AGSP#X0, R5F1006CGSP#X0, R5F1006DGSP#X0, R5F1006EGSP#X0
		Not mounted	A	R5F1016AASP#V0, R5F1016CASP#V0, R5F1016DASP#V0, R5F1016EASP#V0 R5F1016AASP#X0, R5F1016CASP#X0, R5F1016DASP#X0, R5F1016EASP#X0
			D	R5F1016ADSP#V0, R5F1016CDSP#V0, R5F1016DDSP#V0, R5F1016EDSP#V0 R5F1016ADSP#X0, R5F1016CDSP#X0, R5F1016DDSP#X0, R5F1016EDSP#X0
			A	R5F1007AANA#U0, R5F1007CANA#U0, R5F1007DANA#U0, R5F1007EANA#U0 R5F1007AANA#W0, R5F1007CANA#W0, R5F1007DANA#W0, R5F1007EANA#W0
			D	R5F1007ADNA#U0, R5F1007CDNA#U0, R5F1007DDNA#U0, R5F1007EDNA#U0 R5F1007ADNA#W0, R5F1007CDNA#W0, R5F1007DDNA#W0, R5F1007EDNA#W0
			G	R5F1007AGNA#U0, R5F1007CGNA#U0, R5F1007DGNA#U0, R5F1007EGNA#U0 R5F1007AGNA#W0, R5F1007CGNA#W0, R5F1007DGNA#W0, R5F1007EGNA#W0
		Not mounted	A	R5F1017AANA#U0, R5F1017CANA#U0, R5F1017DANA#U0, R5F1017EANA#U0 R5F1017AANA#W0, R5F1017CANA#W0, R5F1017DANA#W0, R5F1017EANA#W0
			D	R5F1017ADNA#U0, R5F1017CDNA#U0, R5F1017DDNA#U0, R5F1017EDNA#U0 R5F1017ADNA#W0, R5F1017CDNA#W0, R5F1017DDNA#W0, R5F1017EDNA#W0

**Note** For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G13**.

**Caution** The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.

Table 1-1. List of Ordering Part Numbers

(3/12)

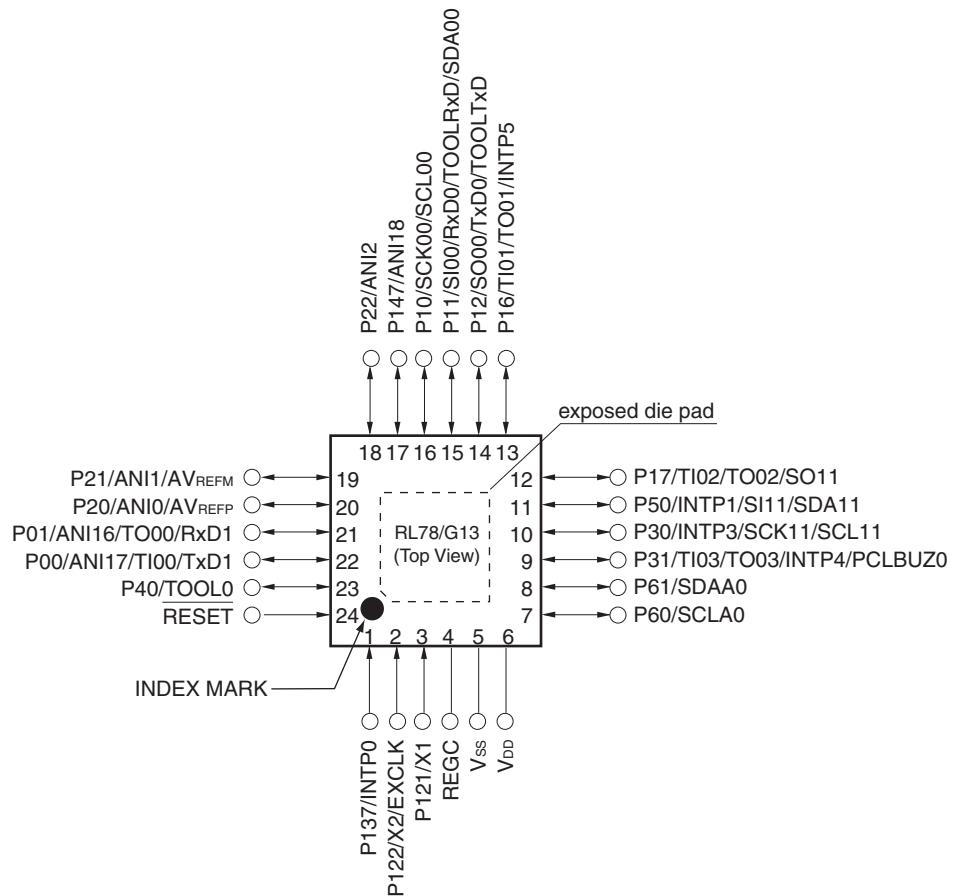
Pin count	Package	Data flash	Fields of Application <small>Note</small>	Ordering Part Number
36 pins	36-pin plastic WFLGA (4 × 4 mm, 0.5 mm pitch)	Mounted	A	R5F100CAALA#U0, R5F100CCALA#U0, R5F100CDALA#U0, R5F100CEAL#U0, R5F100CFALA#U0, R5F100CGALA#U0 R5F100CAALA#W0, R5F100CCALA#W0, R5F100CDALA#W0, R5F100CEAL#W0, R5F100CFALA#W0, R5F100CGALA#W0 R5F100CAGLA#U0, R5F100CCGLA#U0, R5F100CDGLA#U0, R5F100CEGLA#U0, R5F100CFGGLA#U0, R5F100CGGLA#U0 R5F100CAGLA#W0, R5F100CCGLA#W0, R5F100CDGLA#W0, R5F100CEGLA#W0, R5F100CFGGLA#W0, R5F100CGGLA#W0
			G	R5F101CAALA#U0, R5F101CCALA#U0, R5F101CDALA#U0, R5F101CEAL#U0, R5F101CFALA#U0, R5F101CGALA#U0 R5F101CAALA#W0, R5F101CCALA#W0, R5F101CDALA#W0, R5F101CEAL#W0, R5F101CFALA#W0, R5F101CGALA#W0
40 pins	40-pin plastic HWQFN (6 × 6 mm, 0.5 mm pitch)	Mounted	A	R5F100EAANA#U0, R5F100ECANA#U0, R5F100EDANA#U0, R5F100EEANA#U0, R5F100EFANA#U0, R5F100EGANA#U0, R5F100EHANA#U0 R5F100EAANA#W0, R5F100ECANA#W0, R5F100EDANA#W0, R5F100EEANA#W0, R5F100EFANA#W0, R5F100EGANA#W0, R5F100EHANA#W0 R5F100EADNA#U0, R5F100ECDNA#U0, R5F100EDDNA#U0, R5F100EEDNA#U0, R5F100EFDNA#U0, R5F100EGDNA#U0, R5F100EHDNA#U0 R5F100EADNA#W0, R5F100ECDNA#W0, R5F100EDDNA#W0, R5F100EEDNA#W0, R5F100EFDNA#W0, R5F100EGDNA#W0, R5F100EHDNA#W0 R5F100EAGNA#U0, R5F100ECGNA#U0, R5F100EDGNA#U0, R5F100EEGNA#U0, R5F100EFGNA#U0, R5F100EGGNA#U0, R5F100EHGNA#U0 R5F100EAGNA#W0, R5F100ECGNA#W0, R5F100EDGNA#W0, R5F100EEGNA#W0, R5F100EFGNA#W0, R5F100EGGNA#W0, R5F100EHGNA#W0
			D	R5F101EAANA#U0, R5F101ECANA#U0, R5F101EDANA#U0, R5F101EEANA#U0, R5F101EFANA#U0, R5F101EGANA#U0, R5F101EHANA#U0 R5F101EAANA#W0, R5F101ECANA#W0, R5F101EDANA#W0, R5F101EEANA#W0, R5F101EFANA#W0, R5F101EGANA#W0, R5F101EHANA#W0 R5F101EADNA#U0, R5F101ECDNA#U0, R5F101EDDNA#U0, R5F101EEDNA#U0, R5F101EFDNA#U0, R5F101EGDNA#U0, R5F101EHDNA#U0 R5F101EADNA#W0, R5F101ECDNA#W0, R5F101EDDNA#W0, R5F101EEDNA#W0, R5F101EFDNA#W0, R5F101EGDNA#W0, R5F101EHDNA#W0
			G	R5F101EAANA#U0, R5F101ECANA#U0, R5F101EDANA#U0, R5F101EEANA#U0, R5F101EFANA#U0, R5F101EGANA#U0, R5F101EHANA#U0 R5F101EAANA#W0, R5F101ECANA#W0, R5F101EDANA#W0, R5F101EEANA#W0, R5F101EFANA#W0, R5F101EGANA#W0, R5F101EHANA#W0 R5F101EADNA#U0, R5F101ECDNA#U0, R5F101EDDNA#U0, R5F101EEDNA#U0, R5F101EFDNA#U0, R5F101EGDNA#U0, R5F101EHDNA#U0 R5F101EADNA#W0, R5F101ECDNA#W0, R5F101EDDNA#W0, R5F101EEDNA#W0, R5F101EFDNA#W0, R5F101EGDNA#W0, R5F101EHDNA#W0
			Not mounted	R5F101EAANA#U0, R5F101ECANA#U0, R5F101EDANA#U0, R5F101EEANA#U0, R5F101EFANA#U0, R5F101EGANA#U0, R5F101EHANA#U0 R5F101EAANA#W0, R5F101ECANA#W0, R5F101EDANA#W0, R5F101EEANA#W0, R5F101EFANA#W0, R5F101EGANA#W0, R5F101EHANA#W0 R5F101EADNA#U0, R5F101ECDNA#U0, R5F101EDDNA#U0, R5F101EEDNA#U0, R5F101EFDNA#U0, R5F101EGDNA#U0, R5F101EHDNA#U0 R5F101EADNA#W0, R5F101ECDNA#W0, R5F101EDDNA#W0, R5F101EEDNA#W0, R5F101EFDNA#W0, R5F101EGDNA#W0, R5F101EHDNA#W0

**Note** For the fields of application, refer to Figure 1-1 Part Number, Memory Size, and Package of RL78/G13.

**Caution** The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.

### 1.3.2 24-pin products

- 24-pin plastic HWQFN (4 × 4 mm, 0.5 mm pitch)



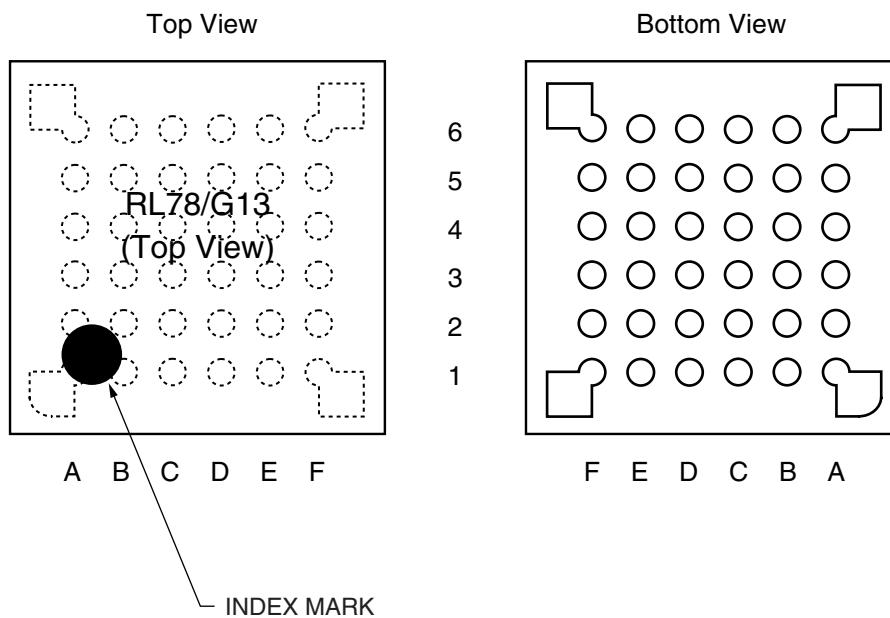
**Caution Connect the REGC pin to V<sub>ss</sub> via a capacitor (0.47 to 1  $\mu$ F).**

**Remarks** 1. For pin identification, see **1.4 Pin Identification**.

2. It is recommended to connect an exposed die pad to V<sub>ss</sub>.

### 1.3.6 36-pin products

- 36-pin plastic WFLGA ( $4 \times 4$  mm, 0.5 mm pitch)



	A	B	C	D	E	F	
6	P60/SCLA0	V <sub>DD</sub>	P121/X1	P122/X2/EXCLK	P137/INTP0	P40/TOOL0	6
5	P62	P61/SDAA0	V <sub>ss</sub>	REGC	RESET	P120/ANI19	5
4	P72/SO21	P71/SI21/SDA21	P14/RxD2/SI20/SDA20/(SCLA0)/(TI03)/(TO03)	P31/TI03/TO03/INTP4/PCLBUZ0	P00/TI00/TxD1	P01/TO00/RxD1	4
3	P50/INTP1/SI11/SDA11	P70/SCK21/SCL21	P15/PCLBUZ1/SCK20/SCL20/(TI02)/(TO02)	P22/ANI2	P20/ANI0/AV <sub>REFP</sub>	P21/ANI1/AV <sub>REFM</sub>	3
2	P30/INTP3/SCK11/SCL11	P16/TI01/TO01/INTP5/(RxD0)	P12/SO00/TxD0/TOOLTxD/(TI05)/(TO05)	P11/SI00/RxD0/TOOLRxDSDA0/(TI06)/(TO06)	P24/ANI4	P23/ANI3	2
1	P51/INTP2/SO11	P17/TI02/TO02/(TxD0)	P13/TxD2/SO20/(SDAA0)/(TI04)/(TO04)	P10/SCK00/SCL00/(TI07)/(TO07)	P147/ANI18	P25/ANI5	1

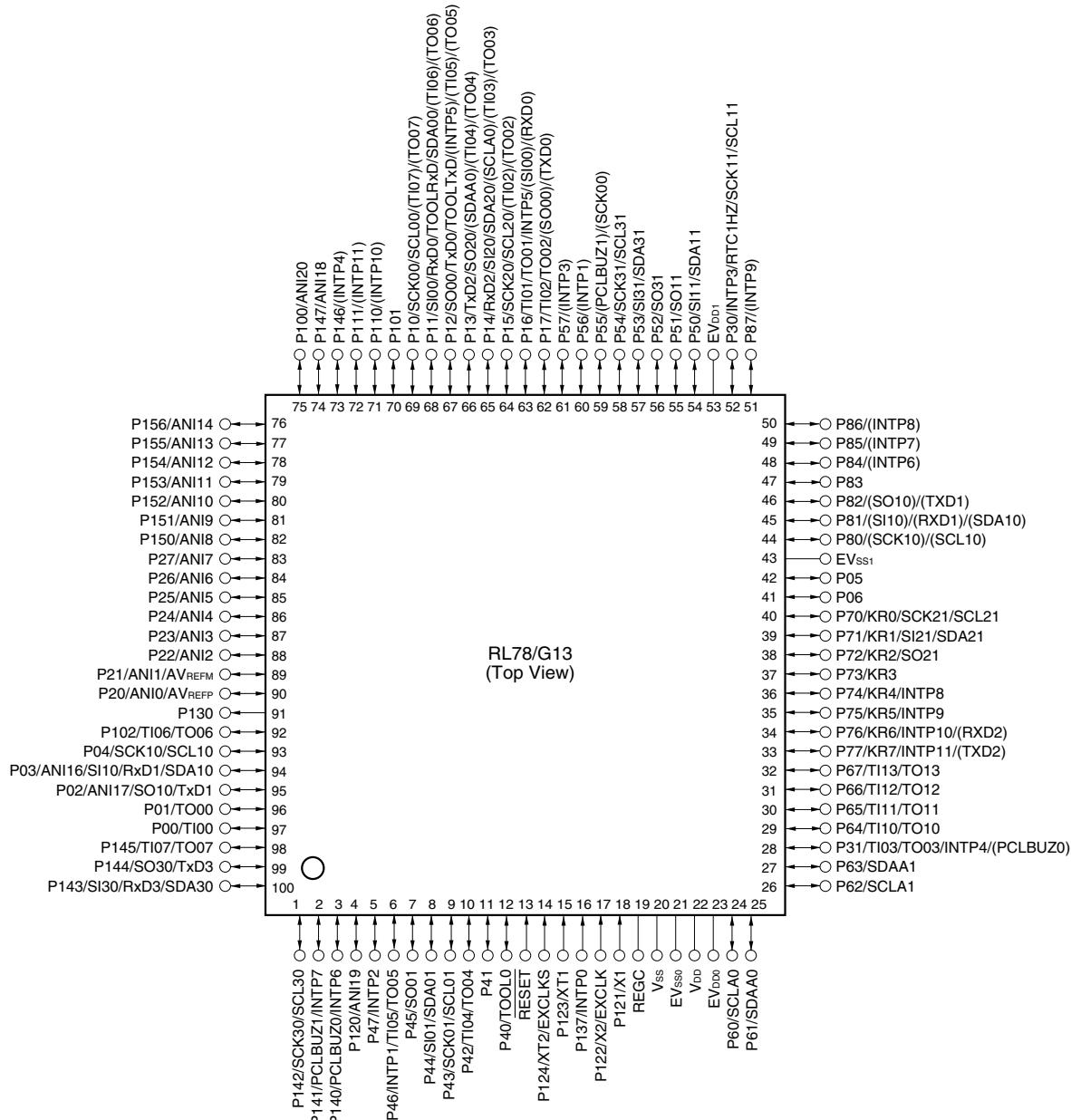
**Caution Connect the REGC pin to V<sub>ss</sub> via a capacitor (0.47 to 1  $\mu$ F).**

**Remarks 1.** For pin identification, see **1.4 Pin Identification**.

2. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

### 1.3.13 100-pin products

- 100-pin plastic LQFP (14 × 14 mm, 0.5 mm pitch)

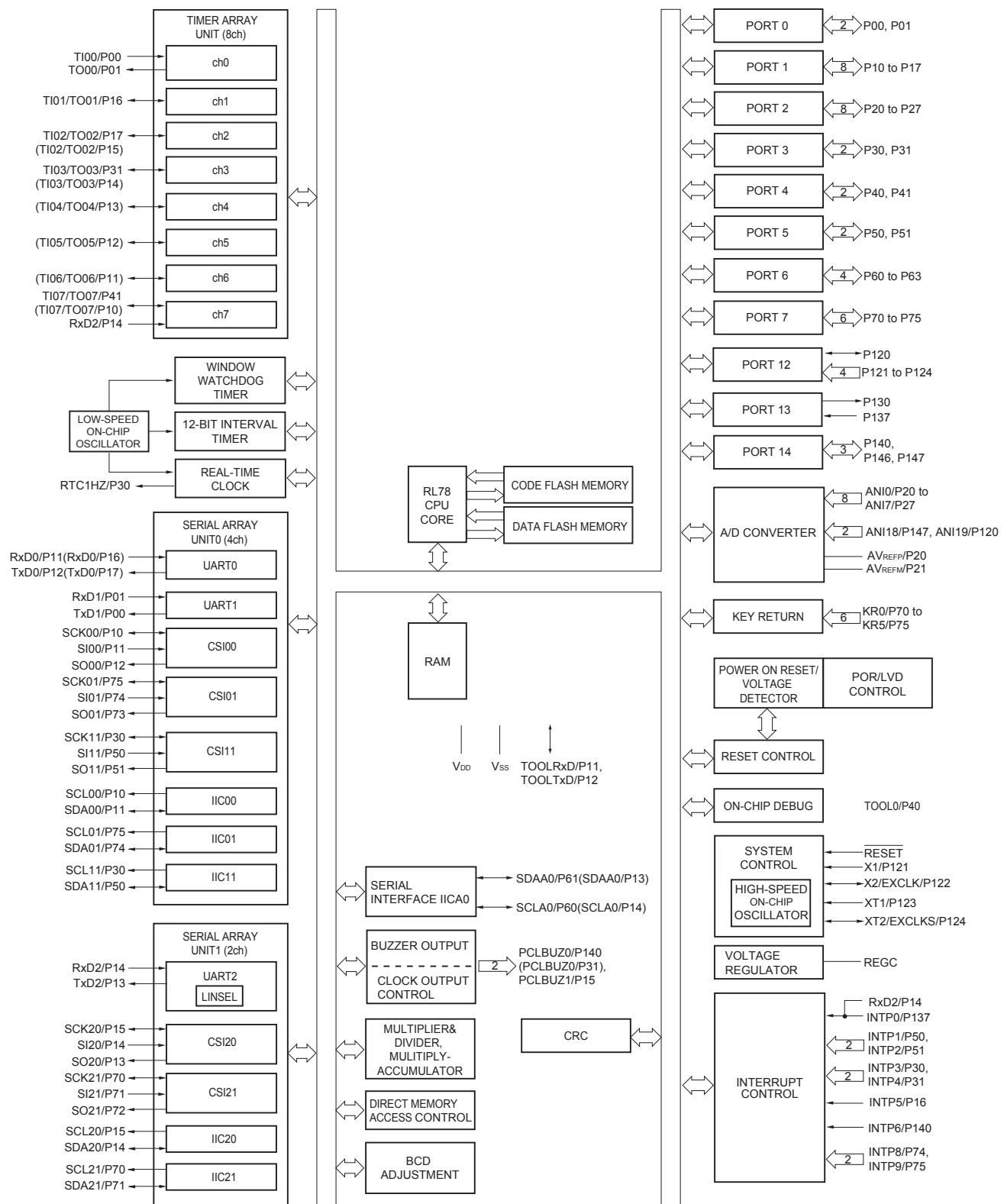


2. Make V<sub>dd</sub> pin the potential that is higher than EV<sub>dd0</sub>, EV<sub>dd1</sub> pins (EV<sub>dd0</sub> = EV<sub>dd1</sub>).
3. Connect the REGC pin to V<sub>ss</sub> via a capacitor (0.47 to 1  $\mu$ F).

**Remarks** 1. For pin identification, see 1.4 Pin Identification.

2. When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the V<sub>dd</sub>, EV<sub>dd0</sub> and EV<sub>dd1</sub> pins and connect the V<sub>ss</sub>, EV<sub>ss0</sub> and EV<sub>ss1</sub> pins to separate ground lines.
3. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

## 1.5.9 48-pin products



**Remark** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

## 1.6 Outline of Functions

[20-pin, 24-pin, 25-pin, 30-pin, 32-pin, 36-pin products]

**Caution This outline describes the functions at the time when Peripheral I/O redirection register (PIOR) is set to 00H.**

Item	20-pin		24-pin		25-pin		30-pin		32-pin		36-pin											
	R5F1006X	R5F1016X	R5F1007X	R5F1017X	R5F1008X	R5F1018X	R5F100AX	R5F101AX	R5F100BX	R5F101BX	R5F100CX	R5F101CX										
Code flash memory (KB)	16 to 64		16 to 64		16 to 64		16 to 128		16 to 128		16 to 128											
Data flash memory (KB)	4	—	4	—	4	—	4 to 8	—	4 to 8	—	4 to 8	—										
RAM (KB)	2 to 4 <sup>Note1</sup>		2 to 4 <sup>Note1</sup>		2 to 4 <sup>Note1</sup>		2 to 12 <sup>Note1</sup>		2 to 12 <sup>Note1</sup>		2 to 12 <sup>Note1</sup>											
Address space	1 MB																					
Main system clock	High-speed system clock	X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK) HS (High-speed main) mode: 1 to 20 MHz ( $V_{DD} = 2.7$ to 5.5 V), HS (High-speed main) mode: 1 to 16 MHz ( $V_{DD} = 2.4$ to 5.5 V), LS (Low-speed main) mode: 1 to 8 MHz ( $V_{DD} = 1.8$ to 5.5 V), LV (Low-voltage main) mode: 1 to 4 MHz ( $V_{DD} = 1.6$ to 5.5 V)																				
	High-speed on-chip oscillator	HS (High-speed main) mode: 1 to 32 MHz ( $V_{DD} = 2.7$ to 5.5 V), HS (High-speed main) mode: 1 to 16 MHz ( $V_{DD} = 2.4$ to 5.5 V), LS (Low-speed main) mode: 1 to 8 MHz ( $V_{DD} = 1.8$ to 5.5 V), LV (Low-voltage main) mode: 1 to 4 MHz ( $V_{DD} = 1.6$ to 5.5 V)																				
Subsystem clock	—																					
Low-speed on-chip oscillator	15 kHz (TYP.)																					
General-purpose registers	(8-bit register × 8) × 4 banks																					
Minimum instruction execution time	0.03125 $\mu$ s (High-speed on-chip oscillator: $f_{IH} = 32$ MHz operation)																					
	0.05 $\mu$ s (High-speed system clock: $f_{MX} = 20$ MHz operation)																					
Instruction set	<ul style="list-style-type: none"> <li>• Data transfer (8/16 bits)</li> <li>• Adder and subtractor/logical operation (8/16 bits)</li> <li>• Multiplication (8 bits × 8 bits)</li> <li>• Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc.</li> </ul>																					
I/O port	Total	16	20	21	26	28	32															
	CMOS I/O	13 (N-ch O.D. I/O [ $V_{DD}$ withstand voltage]: 5)	15 (N-ch O.D. I/O [ $V_{DD}$ withstand voltage]: 6)	15 (N-ch O.D. I/O [ $V_{DD}$ withstand voltage]: 6)	21 (N-ch O.D. I/O [ $V_{DD}$ withstand voltage]: 9)	22 (N-ch O.D. I/O [ $V_{DD}$ withstand voltage]: 9)	26 (N-ch O.D. I/O [ $V_{DD}$ withstand voltage]: 10)															
	CMOS input	3	3	3	3	3	3															
	CMOS output	—	—	1	—	—	—															
	N-ch O.D. I/O (withstand voltage: 6 V)	—	2	2	2	3	3															
Timer	16-bit timer	8 channels																				
	Watchdog timer	1 channel																				
	Real-time clock (RTC)	1 channel <sup>Note 2</sup>																				
	12-bit interval timer (IT)	1 channel																				
	Timer output	3 channels (PWM outputs: 2 <sup>Note 3</sup> )	4 channels (PWM outputs: 3 <sup>Note 3</sup> )	4 channels (PWM outputs: 3 <sup>Note 3</sup> ), 8 channels (PWM outputs: 7 <sup>Note 3</sup> ) <sup>Note 4</sup>																		
	RTC output	—																				

**Notes 1.** The flash library uses RAM in self-programming and rewriting of the data flash memory.

The target products and start address of the RAM areas used by the flash library are shown below.

R5F100xD, R5F101xD (x = 6 to 8, A to C): Start address FF300H

R5F100xE, R5F101xE (x = 6 to 8, A to C): Start address FEF00H

For the RAM areas used by the flash library, see **Self RAM list of Flash Self-Programming Library for RL78 Family (R20UT2944)**.

**2.** Only the constant-period interrupt function when the low-speed on-chip oscillator clock ( $f_{IL}$ ) is selected

## 2. ELECTRICAL SPECIFICATIONS ( $T_A = -40$ to $+85^\circ\text{C}$ )

This chapter describes the following electrical specifications.

Target products A: Consumer applications  $T_A = -40$  to  $+85^\circ\text{C}$

R5F100xxAxx, R5F101xxAxx

D: Industrial applications  $T_A = -40$  to  $+85^\circ\text{C}$

R5F100xxDxx, R5F101xxDxx

G: Industrial applications when  $T_A = -40$  to  $+105^\circ\text{C}$  products is used in the range of  $T_A = -40$  to  $+85^\circ\text{C}$

R5F100xxGxx

- Cautions**
1. **The RL78 microcontrollers have an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.**
  2. **With products not provided with an  $\text{EV}_{\text{DD}0}$ ,  $\text{EV}_{\text{DD}1}$ ,  $\text{EV}_{\text{SS}0}$ , or  $\text{EV}_{\text{SS}1}$  pin, replace  $\text{EV}_{\text{DD}0}$  and  $\text{EV}_{\text{DD}1}$  with  $\text{V}_{\text{DD}}$ , or replace  $\text{EV}_{\text{SS}0}$  and  $\text{EV}_{\text{SS}1}$  with  $\text{V}_{\text{SS}}$ .**
  3. **The pins mounted depend on the product. Refer to 2.1 Port Function to 2.2.1 Functions for each product.**

( $T_A = -40$  to  $+85^\circ\text{C}$ ,  $1.6 \text{ V} \leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{SS} = EV_{SS0} = EV_{SS1} = 0 \text{ V}$ ) (5/5)

Items	Symbol	Conditions		MIN.	TYP.	MAX.	Unit		
Input leakage current, high	$I_{LIH1}$	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P140 to P147		$V_I = EV_{DD0}$		1	$\mu\text{A}$		
	$I_{LIH2}$	P20 to P27, P137, P150 to P156, RESET		$V_I = V_{DD}$		1	$\mu\text{A}$		
	$I_{LIH3}$	P121 to P124 (X1, X2, XT1, XT2, EXCLK, EXCLKS)		$V_I = V_{DD}$	In input port or external clock input	1	$\mu\text{A}$		
						10	$\mu\text{A}$		
Input leakage current, low	$I_{LIL1}$	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P140 to P147		$V_I = EV_{SS0}$		-1	$\mu\text{A}$		
	$I_{LIL2}$	P20 to P27, P137, P150 to P156, RESET		$V_I = V_{SS}$		-1	$\mu\text{A}$		
	$I_{LIL3}$	P121 to P124 (X1, X2, XT1, XT2, EXCLK, EXCLKS)		$V_I = V_{SS}$	In input port or external clock input	-1	$\mu\text{A}$		
						-10	$\mu\text{A}$		
On-chip pll-up resistance	$R_u$	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P140 to P147		$V_I = EV_{SS0}$ , In input port		10	20	100	$k\Omega$

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

## (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products

 $(T_A = -40$  to  $+85^\circ\text{C}$ ,  $1.6 \text{ V} \leq EV_{DD0} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{ss} = EV_{ss0} = 0 \text{ V}$ ) (2/2)

Parameter	Symbol	Conditions			MIN.	TYP.	MAX.	Unit
Supply current <small>Note 1</small>	$I_{DD2}$ <small>Note 2</small>	HALT mode	HS (high-speed main) mode <small>Note 7</small>	$f_{IH} = 32 \text{ MHz}$ <small>Note 4</small>	$V_{DD} = 5.0 \text{ V}$	0.54	1.63	mA
					$V_{DD} = 3.0 \text{ V}$	0.54	1.63	mA
				$f_{IH} = 24 \text{ MHz}$ <small>Note 4</small>	$V_{DD} = 5.0 \text{ V}$	0.44	1.28	mA
					$V_{DD} = 3.0 \text{ V}$	0.44	1.28	mA
				$f_{IH} = 16 \text{ MHz}$ <small>Note 4</small>	$V_{DD} = 5.0 \text{ V}$	0.40	1.00	mA
					$V_{DD} = 3.0 \text{ V}$	0.40	1.00	mA
		LS (low-speed main) mode <small>Note 7</small>	$f_{IH} = 8 \text{ MHz}$ <small>Note 4</small>	$V_{DD} = 3.0 \text{ V}$	260	530	$\mu\text{A}$	
				$V_{DD} = 2.0 \text{ V}$	260	530	$\mu\text{A}$	
		LV (low-voltage main) mode <small>Note 7</small>	$f_{IH} = 4 \text{ MHz}$ <small>Note 4</small>	$V_{DD} = 3.0 \text{ V}$	420	640	$\mu\text{A}$	
				$V_{DD} = 2.0 \text{ V}$	420	640	$\mu\text{A}$	
		HS (high-speed main) mode <small>Note 7</small>	$f_{MX} = 20 \text{ MHz}$ <small>Note 3</small> , $V_{DD} = 5.0 \text{ V}$	Square wave input	0.28	1.00	mA	
				Resonator connection	0.45	1.17	mA	
			$f_{MX} = 20 \text{ MHz}$ <small>Note 3</small> , $V_{DD} = 3.0 \text{ V}$	Square wave input	0.28	1.00	mA	
				Resonator connection	0.45	1.17	mA	
			$f_{MX} = 10 \text{ MHz}$ <small>Note 3</small> , $V_{DD} = 5.0 \text{ V}$	Square wave input	0.19	0.60	mA	
				Resonator connection	0.26	0.67	mA	
			$f_{MX} = 10 \text{ MHz}$ <small>Note 3</small> , $V_{DD} = 3.0 \text{ V}$	Square wave input	0.19	0.60	mA	
				Resonator connection	0.26	0.67	mA	
		LS (low-speed main) mode <small>Note 7</small>	$f_{MX} = 8 \text{ MHz}$ <small>Note 3</small> , $V_{DD} = 3.0 \text{ V}$	Square wave input	95	330	$\mu\text{A}$	
				Resonator connection	145	380	$\mu\text{A}$	
			$f_{MX} = 8 \text{ MHz}$ <small>Note 3</small> , $V_{DD} = 2.0 \text{ V}$	Square wave input	95	330	$\mu\text{A}$	
				Resonator connection	145	380	$\mu\text{A}$	
		Subsystem clock operation	$f_{SUB} = 32.768 \text{ kHz}$ <small>Note 5</small> , $T_A = -40^\circ\text{C}$	Square wave input	0.25	0.57	$\mu\text{A}$	
				Resonator connection	0.44	0.76	$\mu\text{A}$	
			$f_{SUB} = 32.768 \text{ kHz}$ <small>Note 5</small> , $T_A = +25^\circ\text{C}$	Square wave input	0.30	0.57	$\mu\text{A}$	
				Resonator connection	0.49	0.76	$\mu\text{A}$	
			$f_{SUB} = 32.768 \text{ kHz}$ <small>Note 5</small> , $T_A = +50^\circ\text{C}$	Square wave input	0.37	1.17	$\mu\text{A}$	
				Resonator connection	0.56	1.36	$\mu\text{A}$	
			$f_{SUB} = 32.768 \text{ kHz}$ <small>Note 5</small> , $T_A = +70^\circ\text{C}$	Square wave input	0.53	1.97	$\mu\text{A}$	
				Resonator connection	0.72	2.16	$\mu\text{A}$	
			$f_{SUB} = 32.768 \text{ kHz}$ <small>Note 5</small> , $T_A = +85^\circ\text{C}$	Square wave input	0.82	3.37	$\mu\text{A}$	
				Resonator connection	1.01	3.56	$\mu\text{A}$	
$I_{DD3}$ <small>Note 6</small>	STOP mode <small>Note 8</small>	$T_A = -40^\circ\text{C}$			0.18	0.50	$\mu\text{A}$	
		$T_A = +25^\circ\text{C}$			0.23	0.50	$\mu\text{A}$	
		$T_A = +50^\circ\text{C}$			0.30	1.10	$\mu\text{A}$	
		$T_A = +70^\circ\text{C}$			0.46	1.90	$\mu\text{A}$	
		$T_A = +85^\circ\text{C}$			0.75	3.30	$\mu\text{A}$	

(Notes and Remarks are listed on the next page.)

**Notes** 1. Total current flowing into  $V_{DD}$  and  $EV_{DD0}$ , including the input leakage current flowing when the level of the input pin is fixed to  $V_{DD}$ ,  $EV_{DD0}$  or  $V_{SS}$ ,  $EV_{SS0}$ . The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.

2. During HALT instruction execution by flash memory.
3. When high-speed on-chip oscillator and subsystem clock are stopped.
4. When high-speed system clock and subsystem clock are stopped.
5. When high-speed on-chip oscillator and high-speed system clock are stopped. When  $RTCLPC = 1$  and setting ultra-low current consumption ( $AMPHS1 = 1$ ). The current flowing into the RTC is included. However, not including the current flowing into the 12-bit interval timer and watchdog timer.
6. Not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
7. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.

HS (high-speed main) mode:  $2.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$  @ 1 MHz to 32 MHz  
 $2.4 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$  @ 1 MHz to 16 MHz

LS (low-speed main) mode:  $1.8 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$  @ 1 MHz to 8 MHz

LV (low-voltage main) mode:  $1.6 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$  @ 1 MHz to 4 MHz

8. Regarding the value for current to operate the subsystem clock in STOP mode, refer to that in HALT mode.

**Remarks** 1.  $f_{MX}$ : High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)

2.  $f_{IH}$ : High-speed on-chip oscillator clock frequency

3.  $f_{SUB}$ : Subsystem clock frequency (XT1 clock oscillation frequency)

4. Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is  $T_A = 25^\circ\text{C}$

## (3) 128-pin products, and flash ROM: 384 to 512 KB of 44- to 100-pin products

 $(T_A = -40$  to  $+85^\circ\text{C}$ ,  $1.6 \text{ V} \leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{ss} = EV_{ss0} = EV_{ss1} = 0 \text{ V}$ ) (2/2)

Parameter	Symbol	Conditions			MIN.	TYP.	MAX.	Unit
Supply current <small>Note 1</small>	$I_{DD2}^{Note 2}$	HALT mode	HS (high-speed main) mode <sup>Note 7</sup>	$f_{IH} = 32 \text{ MHz}^{Note 4}$	$V_{DD} = 5.0 \text{ V}$		0.62	1.89 mA
				$V_{DD} = 3.0 \text{ V}$			0.62	1.89 mA
			$f_{IH} = 24 \text{ MHz}^{Note 4}$	$V_{DD} = 5.0 \text{ V}$		0.50	1.48	mA
				$V_{DD} = 3.0 \text{ V}$		0.50	1.48	mA
			$f_{IH} = 16 \text{ MHz}^{Note 4}$	$V_{DD} = 5.0 \text{ V}$		0.44	1.12	mA
				$V_{DD} = 3.0 \text{ V}$		0.44	1.12	mA
		LS (low-speed main) mode <sup>Note 7</sup>	$f_{IH} = 8 \text{ MHz}^{Note 4}$	$V_{DD} = 3.0 \text{ V}$		290	620	$\mu\text{A}$
				$V_{DD} = 2.0 \text{ V}$		290	620	$\mu\text{A}$
		LV (low-voltage main) mode <small>Note 7</small>	$f_{IH} = 4 \text{ MHz}^{Note 4}$	$V_{DD} = 3.0 \text{ V}$		460	700	$\mu\text{A}$
				$V_{DD} = 2.0 \text{ V}$		460	700	$\mu\text{A}$
		HS (high-speed main) mode <sup>Note 7</sup>	$f_{MX} = 20 \text{ MHz}^{Note 3}$ , $V_{DD} = 5.0 \text{ V}$	Square wave input		0.31	1.14	mA
				Resonator connection		0.48	1.34	mA
			$f_{MX} = 20 \text{ MHz}^{Note 3}$ , $V_{DD} = 3.0 \text{ V}$	Square wave input		0.31	1.14	mA
				Resonator connection		0.48	1.34	mA
			$f_{MX} = 10 \text{ MHz}^{Note 3}$ , $V_{DD} = 5.0 \text{ V}$	Square wave input		0.21	0.68	mA
				Resonator connection		0.28	0.76	mA
			$f_{MX} = 10 \text{ MHz}^{Note 3}$ , $V_{DD} = 3.0 \text{ V}$	Square wave input		0.21	0.68	mA
				Resonator connection		0.28	0.76	mA
		LS (low-speed main) mode <sup>Note 7</sup>	$f_{MX} = 8 \text{ MHz}^{Note 3}$ , $V_{DD} = 3.0 \text{ V}$	Square wave input		110	390	$\mu\text{A}$
				Resonator connection		160	450	$\mu\text{A}$
			$f_{MX} = 8 \text{ MHz}^{Note 3}$ , $V_{DD} = 2.0 \text{ V}$	Square wave input		110	390	$\mu\text{A}$
				Resonator connection		160	450	$\mu\text{A}$
		Subsystem clock operation	$f_{SUB} = 32.768 \text{ kHz}^{Note 5}$ $T_A = -40^\circ\text{C}$	Square wave input		0.31	0.66	$\mu\text{A}$
				Resonator connection		0.50	0.85	$\mu\text{A}$
			$f_{SUB} = 32.768 \text{ kHz}^{Note 5}$ $T_A = +25^\circ\text{C}$	Square wave input		0.38	0.66	$\mu\text{A}$
				Resonator connection		0.57	0.85	$\mu\text{A}$
			$f_{SUB} = 32.768 \text{ kHz}^{Note 5}$ $T_A = +50^\circ\text{C}$	Square wave input		0.47	3.49	$\mu\text{A}$
				Resonator connection		0.66	3.68	$\mu\text{A}$
			$f_{SUB} = 32.768 \text{ kHz}^{Note 5}$ $T_A = +70^\circ\text{C}$	Square wave input		0.80	6.10	$\mu\text{A}$
				Resonator connection		0.99	6.29	$\mu\text{A}$
			$f_{SUB} = 32.768 \text{ kHz}^{Note 5}$ $T_A = +85^\circ\text{C}$	Square wave input		1.52	10.46	$\mu\text{A}$
				Resonator connection		1.71	10.65	$\mu\text{A}$
	$I_{DD3}^{Note 6}$	STOP mode <sup>Note 8</sup>	$T_A = -40^\circ\text{C}$			0.19	0.54	$\mu\text{A}$
			$T_A = +25^\circ\text{C}$			0.26	0.54	$\mu\text{A}$
			$T_A = +50^\circ\text{C}$			0.35	3.37	$\mu\text{A}$
			$T_A = +70^\circ\text{C}$			0.68	5.98	$\mu\text{A}$
			$T_A = +85^\circ\text{C}$			1.40	10.34	$\mu\text{A}$

(Notes and Remarks are listed on the next page.)

## 2.4 AC Characteristics

**( $T_A = -40$  to  $+85^\circ\text{C}$ ,  $1.6 \text{ V} \leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{SS} = EV_{SS0} = EV_{SS1} = 0 \text{ V}$ )**

Items	Symbol	Conditions			MIN.	TYP.	MAX.	Unit
Instruction cycle (minimum instruction execution time)	TCY	Main system clock ( $f_{MAIN}$ ) operation	HS (high-speed main) mode	$2.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.03125		1	$\mu\text{s}$
				$2.4 \text{ V} \leq V_{DD} < 2.7 \text{ V}$	0.0625		1	$\mu\text{s}$
			LS (low-speed main) mode	$1.8 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.125		1	$\mu\text{s}$
			LV (low-voltage main) mode	$1.6 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.25		1	$\mu\text{s}$
		Subsystem clock ( $f_{SUB}$ ) operation		$1.8 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	28.5	30.5	31.3	$\mu\text{s}$
		In the self programming mode	HS (high-speed main) mode	$2.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.03125		1	$\mu\text{s}$
				$2.4 \text{ V} \leq V_{DD} < 2.7 \text{ V}$	0.0625		1	$\mu\text{s}$
			LS (low-speed main) mode	$1.8 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.125		1	$\mu\text{s}$
			LV (low-voltage main) mode	$1.6 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.25		1	$\mu\text{s}$
External system clock frequency	f <sub>EX</sub>	$2.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$			1.0		20.0	MHz
		$2.4 \text{ V} \leq V_{DD} < 2.7 \text{ V}$			1.0		16.0	MHz
		$1.8 \text{ V} \leq V_{DD} < 2.4 \text{ V}$			1.0		8.0	MHz
		$1.6 \text{ V} \leq V_{DD} < 1.8 \text{ V}$			1.0		4.0	MHz
	f <sub>EXS</sub>				32		35	kHz
External system clock input high-level width, low-level width	t <sub>EXH</sub> , t <sub>EXL</sub>	$2.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$			24			ns
		$2.4 \text{ V} \leq V_{DD} < 2.7 \text{ V}$			30			ns
		$1.8 \text{ V} \leq V_{DD} < 2.4 \text{ V}$			60			ns
		$1.6 \text{ V} \leq V_{DD} < 1.8 \text{ V}$			120			ns
	t <sub>EXHS</sub> , t <sub>EXLS</sub>				13.7			$\mu\text{s}$
TI00 to TI07, TI10 to TI17 input high-level width, low-level width	t <sub>TIH</sub> , t <sub>TIIL</sub>				1/f <sub>MCK</sub> +10			ns <sup>Note</sup>
TO00 to TO07, TO10 to TO17 output frequency	f <sub>TO</sub>	HS (high-speed main) mode	4.0 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				16	MHz
			2.7 V $\leq EV_{DD0} < 4.0 \text{ V}$				8	MHz
			1.8 V $\leq EV_{DD0} < 2.7 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
		LS (low-speed main) mode	1.8 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
		LV (low-voltage main) mode	1.6 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				2	MHz
		HS (high-speed main) mode	4.0 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				16	MHz
			2.7 V $\leq EV_{DD0} < 4.0 \text{ V}$				8	MHz
			1.8 V $\leq EV_{DD0} < 2.7 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
PCLBUZ0, PCLBUZ1 output frequency	f <sub>PCL</sub>	LS (low-speed main) mode	1.8 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
			1.8 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
		LV (low-voltage main) mode	1.8 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
Interrupt input high-level width, low-level width	t <sub>INTH</sub> , t <sub>INTL</sub>	INTP0	$1.6 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	1				$\mu\text{s}$
		INTP1 to INTP11	$1.6 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$	1				$\mu\text{s}$
Key interrupt input low-level width	t <sub>KR</sub>	KR0 to KR7	$1.8 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$	250				ns
			$1.6 \text{ V} \leq EV_{DD0} < 1.8 \text{ V}$	1				$\mu\text{s}$
RESET low-level width	t <sub>RSIL</sub>				10			$\mu\text{s}$

(Note and Remark are listed on the next page.)

- (2) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output, corresponding CSI00 only)

( $T_A = -40$  to  $+85^\circ\text{C}$ ,  $2.7 \text{ V} \leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{SS} = EV_{SS0} = EV_{SS1} = 0 \text{ V}$ )

Parameter	Symbol	Conditions		HS (high-speed main) Mode		LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time	$t_{KCY1}$	$t_{KCY1} \geq 2/f_{CLK}$	$4.0 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$	62.5		250		500		ns
			$2.7 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$	83.3		250		500		ns
SCKp high-/low-level width	$t_{KH1}, t_{KL1}$	$4.0 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$		$t_{KCY1}/2 - 7$		$t_{KCY1}/2 - 50$		$t_{KCY1}/2 - 50$		ns
		$2.7 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$		$t_{KCY1}/2 - 10$		$t_{KCY1}/2 - 50$		$t_{KCY1}/2 - 50$		ns
Slp setup time (to SCKp $\uparrow$ ) <small>Note 1</small>	$t_{SIK1}$	$4.0 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$		23		110		110		ns
		$2.7 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$		33		110		110		ns
Slp hold time (from SCKp $\uparrow$ ) <small>Note 2</small>	$t_{KSI1}$	$2.7 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$		10		10		10		ns
Delay time from SCKp $\downarrow$ to SOp output <small>Note 3</small>	$t_{KS01}$	$C = 20 \text{ pF}$ <small>Note 4</small>			10		10		10	ns

- Notes**
- When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The Slp setup time becomes “to SCKp $\downarrow$ ” when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.
  - When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The Slp hold time becomes “from SCKp $\downarrow$ ” when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.
  - When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes “from SCKp $\uparrow$ ” when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.
  - C is the load capacitance of the SCKp and SOp output lines.

**Caution** Select the normal input buffer for the Slp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).

**Remarks** 1. This value is valid only when CSI00’s peripheral I/O redirect function is not used.

- p: CSI number (p = 00), m: Unit number (m = 0), n: Channel number (n = 0),  
g: PIM and POM numbers (g = 1)
3. f<sub>MCK</sub>: Serial array unit operation clock frequency  
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00))

**LVD Detection Voltage of Interrupt & Reset Mode**(  $T_A = -40$  to  $+85^\circ\text{C}$ ,  $V_{PDR} \leq V_{DD} \leq 5.5$  V,  $V_{SS} = 0$  V )

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Interrupt and reset mode	$V_{LVDA0}$	$V_{POC2}, V_{POC1}, V_{POC0} = 0, 0, 0$ , falling reset voltage	Rising release reset voltage	1.60	1.63	1.66	V
	$V_{LVDA1}$		Falling interrupt voltage	1.74	1.77	1.81	V
	$V_{LVDA2}$		Rising release reset voltage	1.84	1.88	1.91	V
	$V_{LVDA3}$		Falling interrupt voltage	1.80	1.84	1.87	V
	$V_{LVDB0}$	$V_{POC2}, V_{POC1}, V_{POC0} = 0, 0, 1$ , falling reset voltage	Rising release reset voltage	2.86	2.92	2.97	V
	$V_{LVDB1}$		Falling interrupt voltage	2.80	2.86	2.91	V
	$V_{LVDB2}$		Rising release reset voltage	1.94	1.98	2.02	V
	$V_{LVDB3}$		Falling interrupt voltage	1.90	1.94	1.98	V
	$V_{LVDC0}$	$V_{POC2}, V_{POC1}, V_{POC0} = 0, 1, 0$ , falling reset voltage	Rising release reset voltage	2.05	2.09	2.13	V
	$V_{LVDC1}$		Falling interrupt voltage	2.00	2.04	2.08	V
	$V_{LVDC2}$		Rising release reset voltage	3.07	3.13	3.19	V
	$V_{LVDC3}$		Falling interrupt voltage	3.00	3.06	3.12	V
	$V_{LVDD0}$	$V_{POC2}, V_{POC1}, V_{POC0} = 0, 1, 1$ , falling reset voltage	Rising release reset voltage	2.40	2.45	2.50	V
	$V_{LVDD1}$		Falling interrupt voltage	2.56	2.61	2.66	V
	$V_{LVDD2}$		Rising release reset voltage	2.50	2.55	2.60	V
	$V_{LVDD3}$		Falling interrupt voltage	2.66	2.71	2.76	V
	$V_{LVDD0}$		Rising release reset voltage	2.60	2.65	2.70	V
	$V_{LVDD1}$		Falling interrupt voltage	3.68	3.75	3.82	V
	$V_{LVDD2}$		Rising release reset voltage	3.60	3.67	3.74	V
	$V_{LVDD3}$		Falling interrupt voltage	2.96	3.02	3.08	V

**Remark** The electrical characteristics of the products G: Industrial applications ( $T_A = -40$  to  $+105^\circ\text{C}$ ) are different from those of the products "A: Consumer applications, and D: Industrial applications". For details, refer to **3.1 to 3.10**.

### 3.1 Absolute Maximum Ratings

#### Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ ) (1/2)

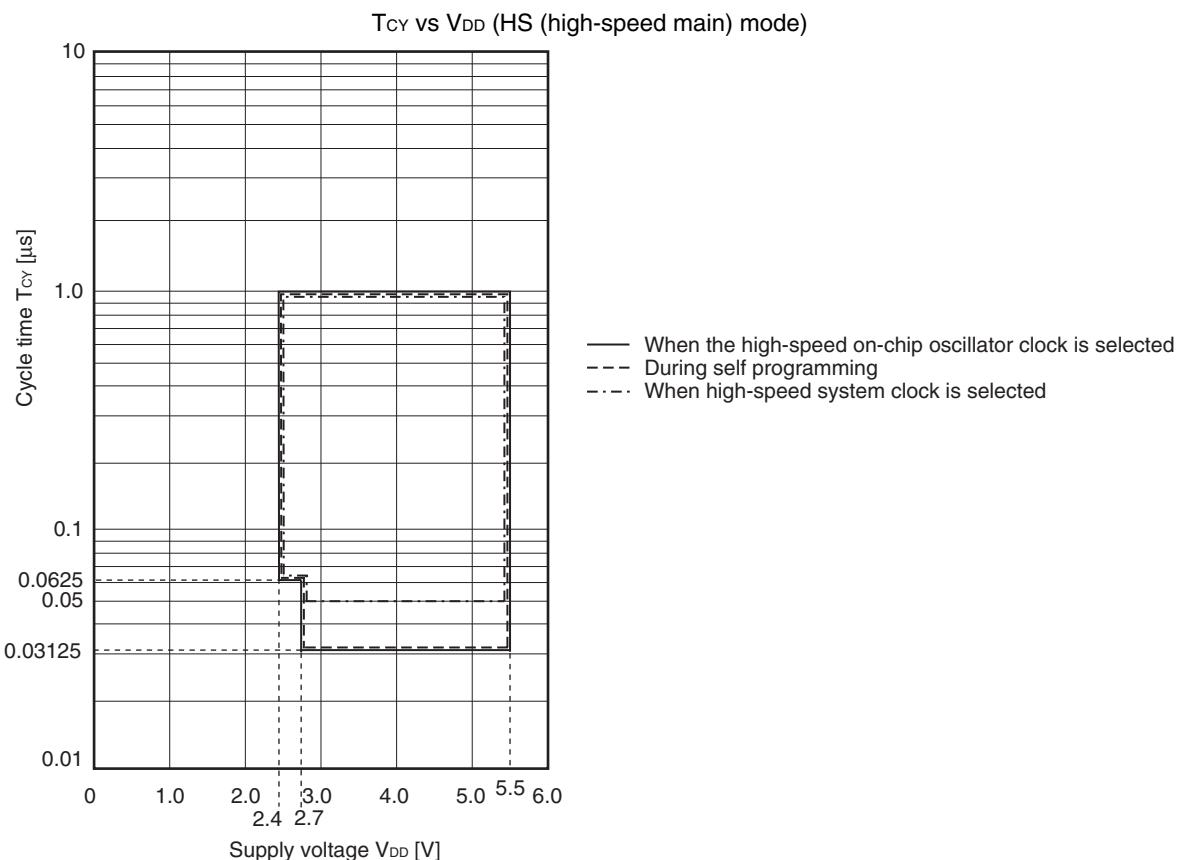
Parameter	Symbols	Conditions	Ratings	Unit
Supply voltage	$V_{DD}$		-0.5 to +6.5	V
	$EV_{DD0}, EV_{DD1}$	$EV_{DD0} = EV_{DD1}$	-0.5 to +6.5	V
	$EV_{SS0}, EV_{SS1}$	$EV_{SS0} = EV_{SS1}$	-0.5 to +0.3	V
REGC pin input voltage	$V_{IREGC}$	REGC	-0.3 to +2.8 and -0.3 to $V_{DD} + 0.3^{\text{Note 1}}$	V
Input voltage	$V_{I1}$	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P140 to P147	-0.3 to $EV_{DD0} + 0.3$ and -0.3 to $V_{DD} + 0.3^{\text{Note 2}}$	V
	$V_{I2}$	P60 to P63 (N-ch open-drain)	-0.3 to +6.5	V
	$V_{I3}$	P20 to P27, P121 to P124, P137, P150 to P156, EXCLK, EXCLKS, RESET	-0.3 to $V_{DD} + 0.3^{\text{Note 2}}$	V
Output voltage	$V_{O1}$	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147	-0.3 to $EV_{DD0} + 0.3$ and -0.3 to $V_{DD} + 0.3^{\text{Note 2}}$	V
	$V_{O2}$	P20 to P27, P150 to P156	-0.3 to $V_{DD} + 0.3^{\text{Note 2}}$	V
Analog input voltage	$V_{AI1}$	ANI16 to ANI26	-0.3 to $EV_{DD0} + 0.3$ and -0.3 to $AV_{REF}(+) + 0.3^{\text{Notes 2, 3}}$	V
	$V_{AI2}$	ANIO to ANI14	-0.3 to $V_{DD} + 0.3$ and -0.3 to $AV_{REF}(+) + 0.3^{\text{Notes 2, 3}}$	V

- Notes 1.** Connect the REGC pin to Vss via a capacitor (0.47 to 1  $\mu\text{F}$ ). This value regulates the absolute maximum rating of the REGC pin. Do not use this pin with voltage applied to it.
2. Must be 6.5 V or lower.
  3. Do not exceed  $AV_{REF}(+) + 0.3$  V in case of A/D conversion target pin.

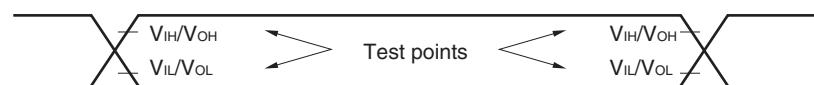
**Caution** Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

- Remarks**
1. Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.
  2.  $AV_{REF}(+)$  : + side reference voltage of the A/D converter.
  3.  $V_{ss}$  : Reference voltage

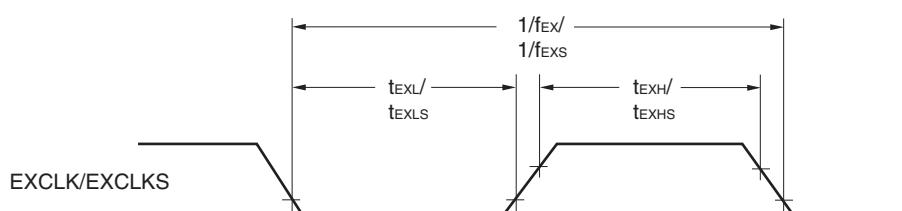
### Minimum Instruction Execution Time during Main System Clock Operation



### AC Timing Test Points



### External System Clock Timing



(4) During communication at same potential (simplified I<sup>2</sup>C mode)(TA = -40 to +105°C, 2.4 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)

Parameter	Symbol	Conditions	HS (high-speed main) Mode		Unit
			MIN.	MAX.	
SCL <sub>r</sub> clock frequency	f <sub>SCL</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, C <sub>b</sub> = 50 pF, R <sub>b</sub> = 2.7 kΩ		400 <sup>Note1</sup>	kHz
		2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, C <sub>b</sub> = 100 pF, R <sub>b</sub> = 3 kΩ		100 <sup>Note1</sup>	kHz
Hold time when SCL <sub>r</sub> = "L"	t <sub>LOW</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, C <sub>b</sub> = 50 pF, R <sub>b</sub> = 2.7 kΩ	1200		ns
		2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, C <sub>b</sub> = 100 pF, R <sub>b</sub> = 3 kΩ	4600		ns
Hold time when SCL <sub>r</sub> = "H"	t <sub>HIGH</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, C <sub>b</sub> = 50 pF, R <sub>b</sub> = 2.7 kΩ	1200		ns
		2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, C <sub>b</sub> = 100 pF, R <sub>b</sub> = 3 kΩ	4600		ns
Data setup time (reception)	t <sub>SU:DAT</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, C <sub>b</sub> = 50 pF, R <sub>b</sub> = 2.7 kΩ	1/f <sub>MCK</sub> + 220 <sup>Note2</sup>		ns
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V, C <sub>b</sub> = 100 pF, R <sub>b</sub> = 3 kΩ	1/f <sub>MCK</sub> + 580 <sup>Note2</sup>		ns
Data hold time (transmission)	t <sub>HD:DAT</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, C <sub>b</sub> = 50 pF, R <sub>b</sub> = 2.7 kΩ	0	770	ns
		2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, C <sub>b</sub> = 100 pF, R <sub>b</sub> = 3 kΩ	0	1420	ns

**Notes** 1. The value must also be equal to or less than f<sub>MCK</sub>/4.2. Set the f<sub>MCK</sub> value to keep the hold time of SCL<sub>r</sub> = "L" and SCL<sub>r</sub> = "H".**Caution** Select the normal input buffer and the N-ch open drain output (V<sub>DD</sub> tolerance (for the 20- to 52-pin products)/EV<sub>DD</sub> tolerance (for the 64- to 100-pin products)) mode for the SDAr pin and the normal output mode for the SCL<sub>r</sub> pin by using port input mode register g (PIMg) and port output mode register h (POMh).

(Remarks are listed on the next page.)

**(6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output) (2/3)**

(TA = -40 to +105°C, 2.4 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>ss</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)

Parameter	Symbol	Conditions	HS (high-speed main) Mode		Unit
			MIN.	MAX.	
Slp setup time (to SCKp↑) <sup>Note</sup>	t <sub>SIK1</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ	162		ns
		2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	354		ns
		2.4 V ≤ EV <sub>DD0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ	958		ns
Slp hold time (from SCKp↑) <sup>Note</sup>	t <sub>KSI1</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ	38		ns
		2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	38		ns
		2.4 V ≤ EV <sub>DD0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	38		ns
Delay time from SCKp↓ to SO <sub>p</sub> output <sup>Note</sup>	t <sub>KSO1</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ		200	ns
		2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ		390	ns
		2.4 V ≤ EV <sub>DD0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ		966	ns

**Note** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.

**Caution** Select the TTL input buffer for the Slp pin and the N-ch open drain output (V<sub>DD</sub> tolerance (for the 20- to 52-pin products)/EV<sub>DD</sub> tolerance (for the 64- to 100-pin products)) mode for the SO<sub>p</sub> pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V<sub>IH</sub> and V<sub>IL</sub>, see the DC characteristics with TTL input buffer selected.

(Remarks are listed on the page after the next page.)

### 3.6.3 POR circuit characteristics

( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $V_{SS} = 0$  V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Detection voltage	$V_{POR}$	Power supply rise time	1.45	1.51	1.57	V
	$V_{PDR}$	Power supply fall time	1.44	1.50	1.56	V
Minimum pulse width	$T_{PW}$		300			$\mu\text{s}$

**Note** Minimum time required for a POR reset when  $V_{DD}$  exceeds below  $V_{PDR}$ . This is also the minimum time required for a POR reset from when  $V_{DD}$  exceeds below 0.7 V to when  $V_{DD}$  exceeds  $V_{POR}$  while STOP mode is entered or the main system clock is stopped through setting bit 0 (HIOSTOP) and bit 7 (MSTOP) in the clock operation status control register (CSC).

